

ELECTRICAL CHARACTERISTICS
STATIC CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit		
$V_{(BR)}$	$I_R = 10\mu A$		BAT47	20			V		
	$I_R = 25\mu A$		BAT48	40					
V_F^*	$T_j = 25^{\circ}C$ $I_F = 0.1mA$	All Types				0.25	V		
	$T_j = 25^{\circ}C$ $I_F = 1mA$					0.3			
	$T_j = 25^{\circ}C$ $I_F = 10mA$					0.4			
	$T_j = 25^{\circ}C$ $I_F = 30mA$	BAT47				0.5			
	$T_j = 25^{\circ}C$ $I_F = 150mA$					0.8			
	$T_j = 25^{\circ}C$ $I_F = 300mA$					1			
	$T_j = 25^{\circ}C$ $I_F = 50mA$	BAT48				0.5			
	$T_j = 25^{\circ}C$ $I_F = 200mA$					0.75			
	$T_j = 25^{\circ}C$ $I_F = 500mA$					0.9			
I_R^*	$T_j = 25^{\circ}C$	$V_R = 1.5V$	All Types			1	μA		
	$T_j = 60^{\circ}C$					10			
	$T_j = 25^{\circ}C$	$V_R = 10V$	BAT47			4			
	$T_j = 60^{\circ}C$					20			
	$T_j = 25^{\circ}C$	$V_R = 20V$				10			
	$T_j = 60^{\circ}C$					30			
	$T_j = 25^{\circ}C$	$V_R = 10V$	BAT48			2			
	$T_j = 60^{\circ}C$					15			
	$T_j = 25^{\circ}C$	$V_R = 20V$				5			
	$T_j = 60^{\circ}C$					25			
	$T_j = 25^{\circ}C$	$V_R = 40V$				25			
	$T_j = 60^{\circ}C$					50			

DYNAMIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
C	$T_j = 25^\circ C$ $V_R = 0V$	$f = 1MHz$		20		pF
	$T_j = 25^\circ C$ $V_R = 1V$			12		

* Pulse test: $t_p \leq 300\mu s$ $\delta < 2\%$.

Fig. 1: Forward current versus forward voltage at different temperatures (typical values).

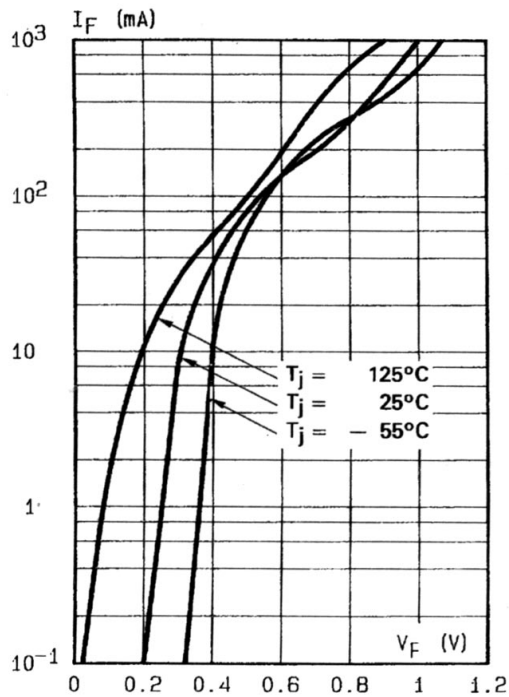


Fig. 2: Forward current versus forward voltage (typical values).

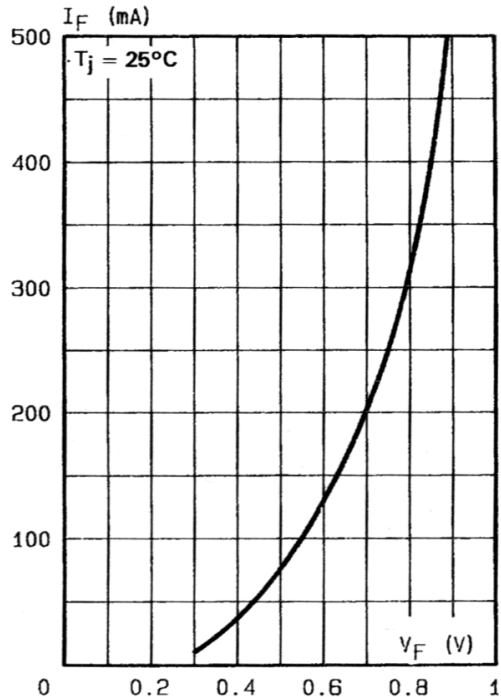


Fig. 3: Reverse current versus junction temperature.

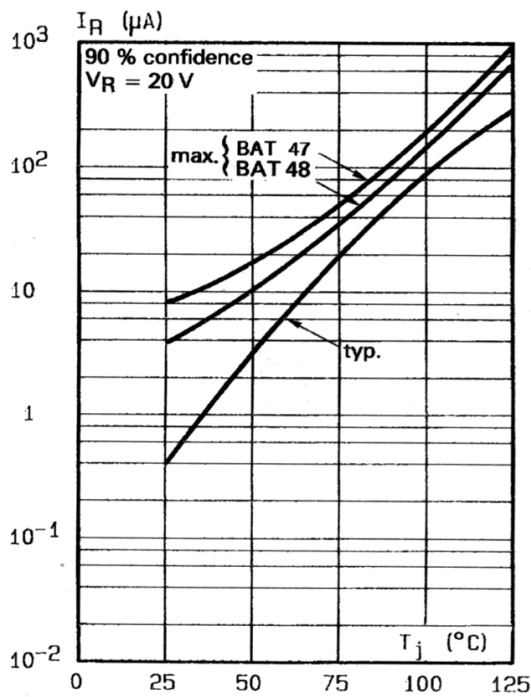


Fig. 4: Reverse current versus continuous reverse voltage (typical values).

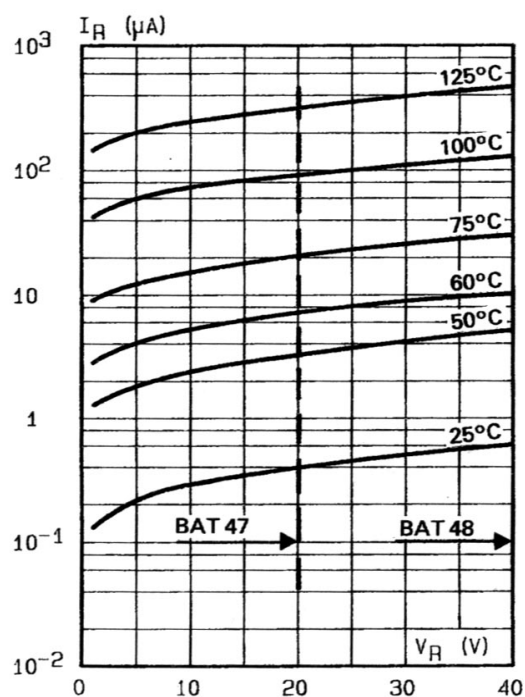
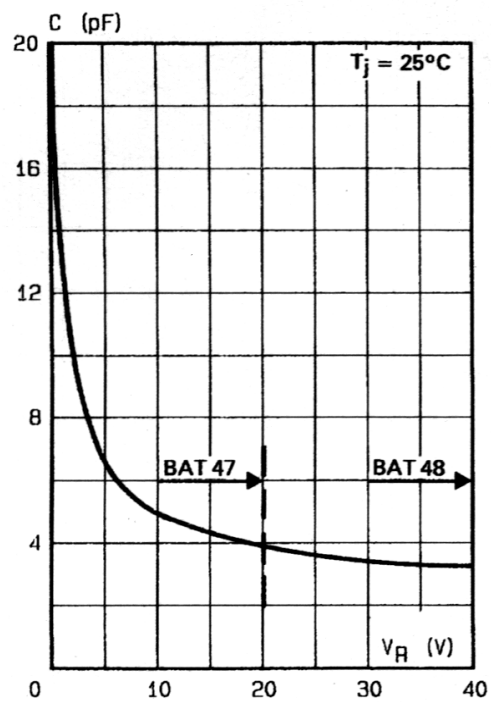
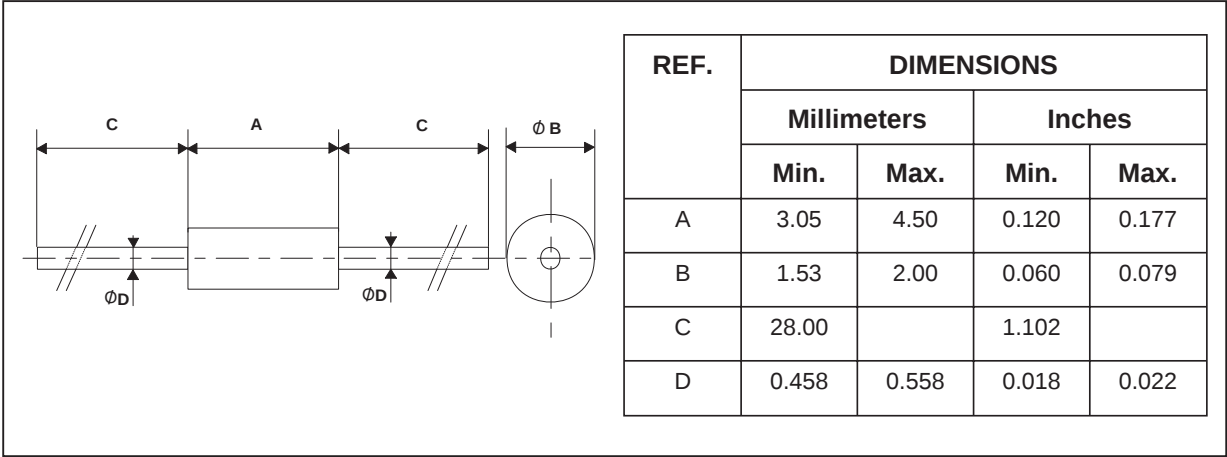


Fig. 5: Capacitance C versus reverse applied voltage V_R (typical values).



PACKAGE MECHANICAL DATA
DO-35



Cooling method: by convection and conduction.
Marking: clear, ring at cathode end.
Weight: 0.015g

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